



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: [info@chipsmall.com](mailto:info@chipsmall.com) Web: [www.chipsmall.com](http://www.chipsmall.com)

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



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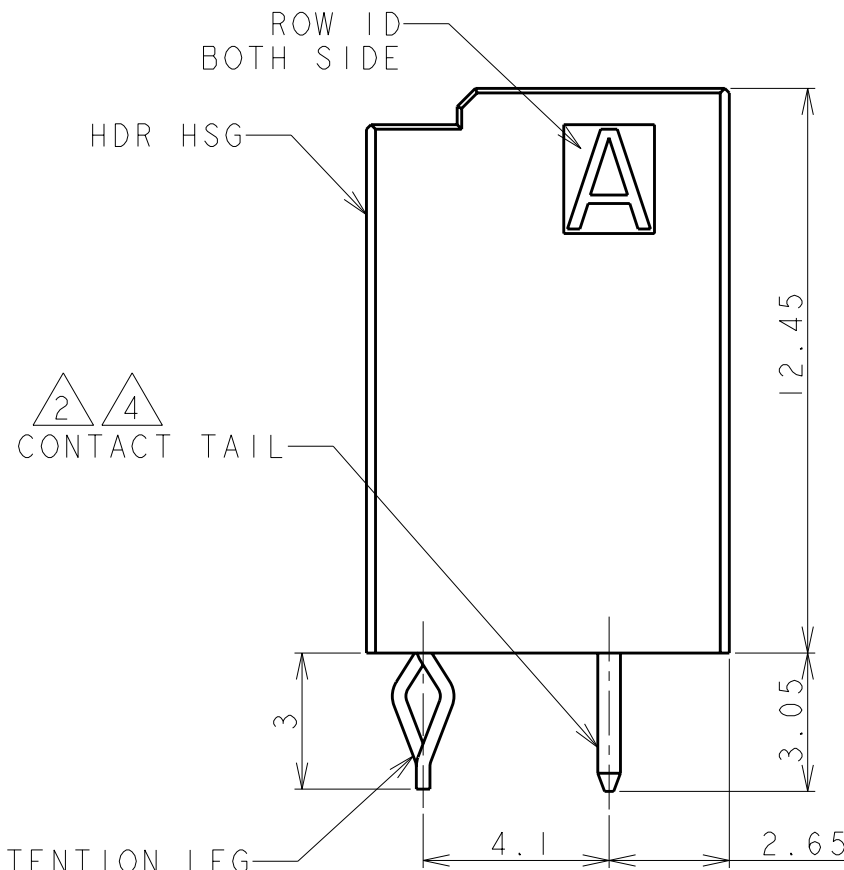
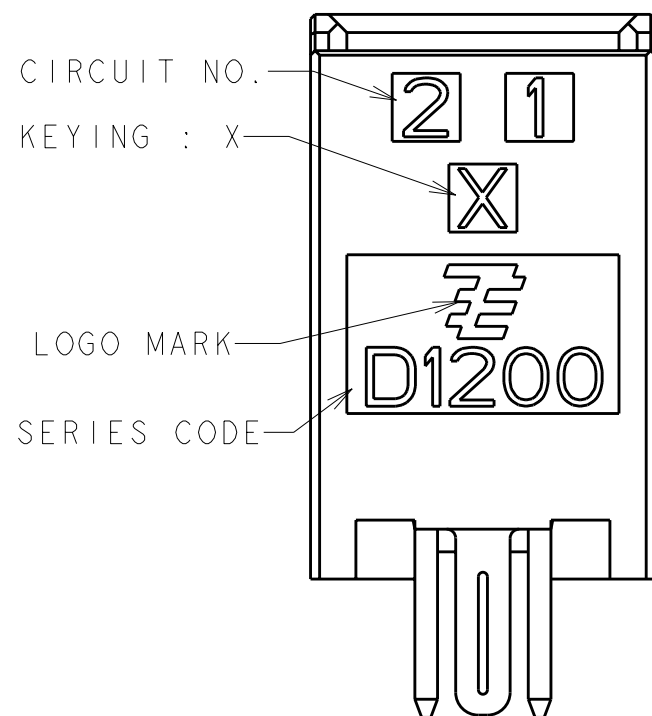
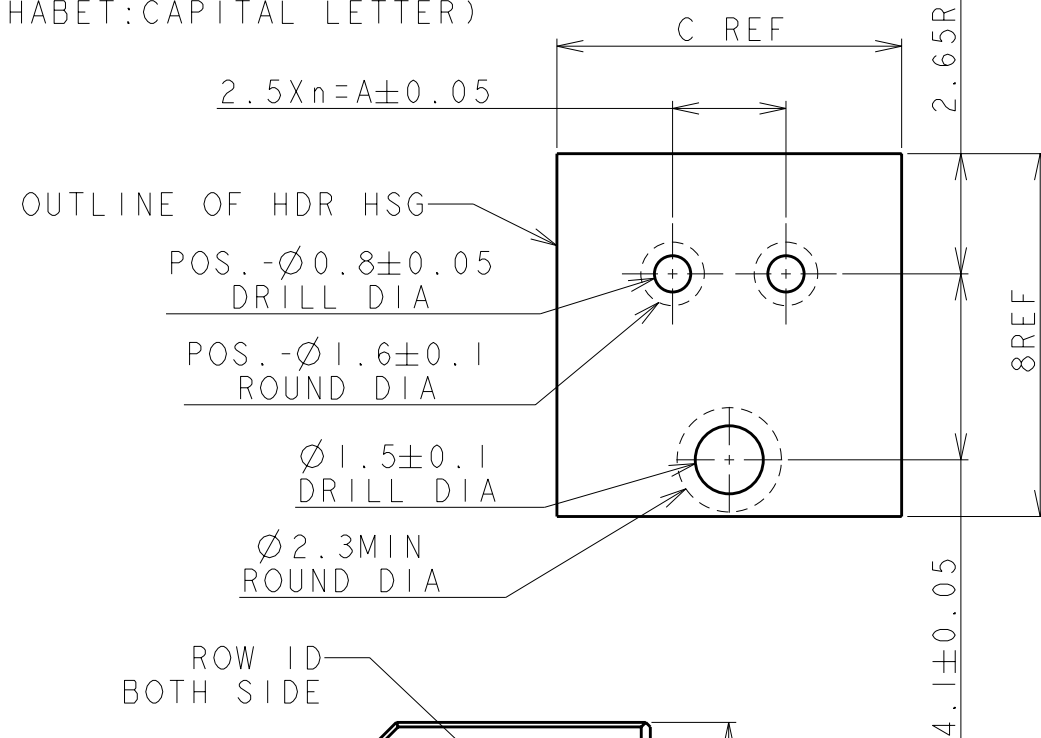
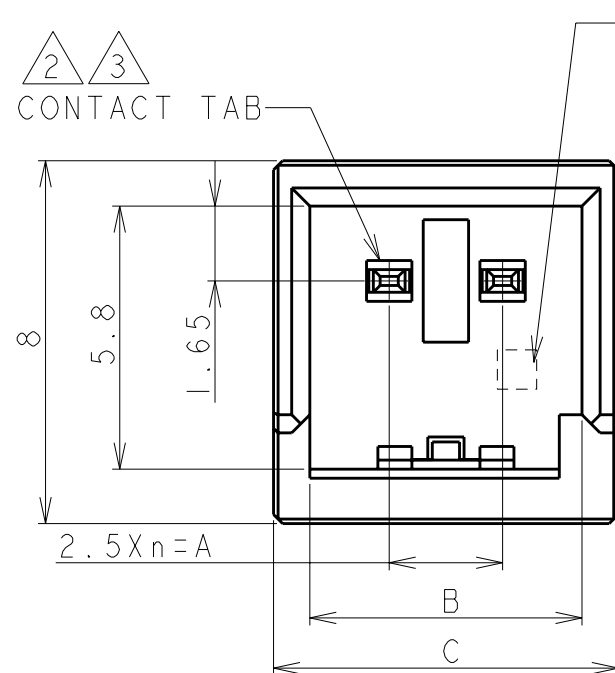
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LOC J	DIST /	REVISIONS 変更					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
			BI	REVISED PER ECR-10-019595	04OCT10	HMR	T.M



RECOMMEND PC BOARD HOLE PATTERN  
: CONNECTOR MOUNT SIDE (NOT ACCUMULATE TOLERANCE)  
PC BOARD THICKNESS : 1.0~1.6 ± 0.1  
推奨基板取付寸法 : コネクタ搭載面 (非累積公差)  
PC基板厚 : 1.0~1.6 ± 0.1

1. MATERIAL: HOUSING: GLASS FILLED THERMO PLASTIC  
POLYESTER (94V-0), COLOR: BLACK  
CONTACT: COPPER ALLOY  
RETENTION LEG: Pre-Tin COPPER ALLOY

- 2 FINISH (ALL OVER): NICKEL PL. 1.27 μm MIN
- 3 FINISH (CONTACT AREA): AU PL. 0.38 μm MIN AFTER 2
- 4 FINISH (CONTACT TAIL): TIN PL. 2 μm MIN AFTER 2
- 5. THE SHAPE, SIZE AND POSITION OF THE CHARACTER  
SHOW THE OUTLINE.  
THEY DON'T SHOW DETAILS.

1. 材料: ハウジング: ガラス入り熱可塑性ポリエステル樹脂 (94V-0)、色: 黒  
コンタクト: 銅合金  
リテンションレグ: 錫めっき済銅合金

- 2 めっき: 全面: Ni下地めっき 1.27 μm 以上
- 3 めっき: 接触部: 2 の上に金めっき 0.38 μm 以上
- 4 めっき: コンタクト半田付部: 2 の上に錫めっき 2 μm 以上
- 5. 文字の形状、大きさ、および位置については、大略を示すものであり、  
詳細を示すものではありません。

P/N 1-1871468-2  
(2P: X-KEY)

THIS DRAWING IS A CONTROLLED DOCUMENT FOR TYCO ELECTRONICS CORPORATION IT IS SUBJECT TO CHANGE AND THE CONTROLLING ENGINEERING ORGANIZATION SHOULD BE CONTACTED FOR THE LATEST REVISION.		DWN M. MAEBASHI 20JUN2005	Tyco Electronics Corporation Kawasaki, Japan			
DIMENSIONS: 単位: 耗 mm		CHK T. KUDO 20JUN2005				
TOLERANCES UNLESS OTHERWISE SPECIFIED: 一般公差 ± 0.3, ± 3° 0-PLC ± 1-PLC ± 2-PLC ± 3-PLC ± 4-PLC ± ANGLES ±		APVD D. MITSUGI 31AUG2005	NAME 名称 DYNAMIC DI200S 2.5mm PITCH HDR ASSY, V-TYPE 2 POS			
MATERIAL 材料		PRODUCT SPEC 製品規格 108-78268	SIZE A3			
FINISH 仕上		APPLICATION SPEC 取付適用規格 114-5377	CAGE CODE 00779			
		WEIGHT	DRAWING NO C=1871468			
		CUSTOMER DRAWING	RESTRICTED TO			
			SCALE 尺度 6:1			
			SHEET 1 OF 1			
			REV BI			